PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT3196220

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SATOSHI SEKINE	12/30/2014
CHEONG MIN HONG	12/10/2014

RECEIVING PARTY DATA

Name:	FREESCALE SEMICONDUCTOR, INC.		
Street Address:	6501 WILLIAM CANNON DR.		
Internal Address:	TX30/OE62		
City:	AUSTIN		
State/Country:	TEXAS		
Postal Code:	78735		

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	14604323	

CORRESPONDENCE DATA

Fax Number: (512)895-6630

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 512-895-6979

Email: dee.matocha@freescale.com

FREESCALE SEMICONDUCTOR, INC. **Correspondent Name:**

Address Line 1: 6501 WILLIAM CANNON DR.

Address Line 2: TX30/OE62

Address Line 4: AUSTIN, TEXAS 78735

ATTORNEY DOCKET NUMBER:	AM21213TP
NAME OF SUBMITTER:	DEE MATOCHA
SIGNATURE:	/Dee Matocha/
DATE SIGNED:	01/23/2015

Total Attachments: 6

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> **PATENT** REEL: 034803 FRAME: 0341 503149608

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> PATENT REEL: 034803 FRAME: 0342

ASSIGNMENT AND AGREEMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, we, SATOSHI SEKINE, an individual; and, CHEONG MIN HONG, an individual, have sold, assigned and transferred, and do hereby sell, assign and transfer, unto FREESCALE SEMICONDUCTOR, INC., a corporation of the State of Delaware, having its principal office in Austin, State of Texas, United States of America, and its successors, assigns, and legal representatives, the entire right, title and interest for the United States of America in and to certain inventions relating to improvements in NON-VOLATILE MEMORY (NVM) CELL AND DEVICE STRUCTURE INTEGRATION (Docket No. AM21213TP), described, illustrated and claimed in an application for Letters Patent of the United States of America executed by us on the dates indicated by our signatures below, together with the entire right, title and interest in and to the application, and in and to Letters Patent which may be issued upon the application, and upon any division, extension, continuation or reissue thereof.

We hereby also sell, assign and transfer unto FREESCALE SEMICONDUCTOR, INC., the entire right, title and interest in and to the invention and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the invention and the applications for Letters Patent in foreign countries, and we further authorize FREESCALE SEMICONDUCTOR, INC. to apply for Letters Patent in foreign countries directly in its own name, and to claim priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

We hereby authorize and request the Commissioner of Patents of the United States of America to issue Letters Patent upon the aforesaid application, division, extension, continuation or reissue, to FREESCALE SEMICONDUCTOR, INC., for the sole use and benefit of FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives, to the full end of the term for which Letters Patent may be granted, the same as they would have been held and enjoyed by me had this assignment not been made, and we hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to FREESCALE SEMICONDUCTOR, INC.

We agree that, when requested, we will, without charge to FREESCALE SEMICONDUCTOR, INC., but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable or convenient for securing and maintaining patents for the inventions in any and all countries and for vesting title thereto in FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives or nominees.

We covenant with FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives, that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license or other encumbrance.

AM21213TP

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Septh, Sehri SATOSHI SEKINE	DATE: 12-30-2014
First Witness Yuko Sekine	DATE: <u>/2 - 30 - 2014</u> (Month-Day-Year)
SIGNATURE OF WITNESS YUKO SEKINE PRINTED NAME OF WITNESS	(Month-Day-Year)
4-18-9, Katsura, Izumi-ku, Sendai PRINTED ADDRESS OF WITNESS	, Miyagi 981-3134 Japan.

	Marana de la compansión d
Second Witness	
Signature of Witness DATE: 12-30-2014 (Month-Day-Year)	unauthar
SAORI SEKINE PRINTED NAME OF WITNESS	
4-18-9. Katsura. Izumi-ku Sendai, Miyagi 981-3134 JAPAN PRINTED ADDRESS OF WITNESS	

CHEONG MIN I	IONG]	DATE:	
STATE OF TE	EXAS)		
COUNTY OF TE	RAVIS)		
that CHEONG M before me this da	IN HON	IG, whose name is subson and acknowledged	scribed to the fore that they signed, s	e aforesaid does hereby certify egoing instrument, appeared sealed and delivered the d purposes therein set forth.
Given under i	ny hand	and notarial seal this _	day of	, 2014.
My commission expi	res:		Notary Pub	elic Signature

ASSIGNMENT AND AGREEMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, we, SATOSHI SEKINE, an individual; and, CHEONG MIN HONG, an individual, have sold, assigned and transferred, and do hereby sell, assign and transfer, unto FREESCALE SEMICONDUCTOR, INC., a corporation of the State of Delaware, having its principal office in Austin, State of Texas, United States of America, and its successors, assigns, and legal representatives, the entire right, title and interest for the United States of America in and to certain inventions relating to improvements in MON-VOLATILE MEMORY (NVM) CELL AND DEVICE STRUCTURE INTEGRATION (Docket No. AM21213TP), described, illustrated and claimed in an application for Letters Patent of the United States of America executed by us on the dates indicated by our signatures below, together with the entire right, title and interest in and to the application, and in and to Letters Patent which may be issued upon the application, and upon any division, extension, continuation or reissue thereof.

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We hereby authorize and request the Commissioner of Patents of the United States of America to issue Letters Patent upon the aforesaid application, division, extension, continuation or reissue, to FREESCALE SEMICONDUCTOR, INC., for the sole use and benefit of FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives, to the full end of the term for which Letters Patent may be granted, the same as they would have been held and enjoyed by me had this assignment not been made, and we hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to FREESCALE SEMICONDUCTOR, INC.

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SATOSHI SEKINE	DATE:	
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<u>First Witness</u>	ripodistrational de la constantina del constantina del constantina de la constantin	
SIGNATURE OF WITNESS	DATE:	(Month-Day-Year)
PRINTED NAME OF WITNESS		
PRINTED ADDRESS OF WITNESS		
Second Witness		
SIGNATURE OF WITNESS	DATE:	(Month-Day-Year)
PRINTED NAME OF WITNESS		
PRINTED ADDRESS OF WITNESS		

CHEONG MIN HONG	DATE	:	10,2014
STATE OF TEXAS COUNTY OF TRAVIS))		
that CHEONG MIN HONG before me this day in person instrument as their free and	and acknowledged that the coluntary act and deed for d notarial seal this day	to the foregoing instruey signed, sealed and detection the uses and purposes t	ment, appeared elivered the

DEE A. MATOCHA My Commission Expires October 31, 2018

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